INolux RGB CHIP LED Data Sheet
IN-B101FCH

DISCLAIMER

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LIFE SUPPORT POLICY

INOLUX's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of INOLUX or INOLUX CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Product Specifications

	Specification	Material	Quantity
Iv	R: 58 mcd typical G: 85 mcd typical B: 17 mcd typical R@10mA; G/B@5mA / Ta= 25°C; Tolerance ±10%		
λD	R: 621 nm typical G: 529 nm typical B: 470 nm typical R@10mA; G/B@5mA / Ta= 25° C; Tolerance ± 0.5nm		
Vf	R: 2.4 V maximum G: 3.4 V maximum B: 3.4 V maximum R@10mA; G/B@5mA / Ta= 25o C; Tolerance ± 0.05V		
Ir	<100uA@ V_R=5V		
Resin	Dark	Epoxy Resin	
Carrier tape	EIA 481-1A specs	Conductive black tape	24000 pcs/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection

The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Label Specifications

■ INolux P/N:

I N - B 1 0 1 F C H - X X X X

Product	Package	Color	Customer Code
IN: INolux Technologies	B101: 1.0 (L) x 1.0 (W) x 0.65 (H) mm	FCH: RGB	XXXX: Customer Specific Code

■ Lot No.:

1	2	3	4	5	6	7	8	9	10
1	7	N	E	4	1	L	N	1	1
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
			Mfg.Year	Mfg.Month	Consecutive number		Special code		
Internal Tracing Code		Mixing Lot No.	2010-A 2011-B 2012-C 2013-D 2014-E . . .	1:Jan 2:Feb ..... A:Oct B:Nov C:Dec	01~ZZ		000~ZZZ		

Specifications Range

■Luminous Intensity (Iv) Bin:

B101FCH								
IV								
Red			Green			Blue		
FK3	43.7	52.5	FM1	63	75.6	FF2	13	15.6
FL1	47.2	56.7	FM2	68.5	82.5	FF3	14.5	17.5
FL2	52.5	63	FM3	75.6	91	FG1	15.6	18.8
FL3	56.7	68.5	FN1	82.5	99	FG2	17.5	21
FM1	63	75.6	FN2	91	110	FG3	18.8	22.6
FM2	68.5	82.5	FN3	99	119	FH1	21	25.2

Note: It maintains a tolerance of ±10% on luminous intensity

■Color Bin:

B101FCH								
WD								
Red			Green			Blue		
R1	616	620	G1	523	526	B1	464	467
R2	620	624	G2	526	529	B2	467	470
R3	624	628	G3	529	532	B3	470	473
R4	628	632	G4	532	535	B4	473	476
			G5	535	538	B5	476	479

Note: It maintains a tolerance of ± 0.5nm on color

■Forward Voltage (Vf) Bin:

B101FCH								
Vf								
Red			Green			Blue		
-	1.6	2.4	-	2.4	3.4	-	2.4	3.4

Note: It maintains a tolerance of ±0.05V on forward voltage measurements

Product Features

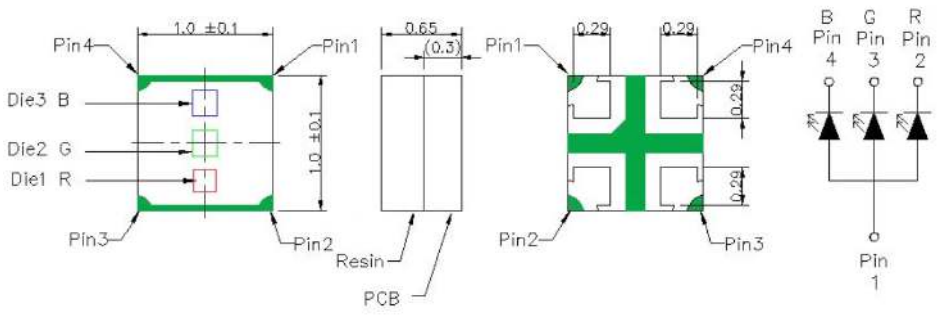
Electro-Optical Characteristics

(I_F @ 10mA, T_a 25 °C)

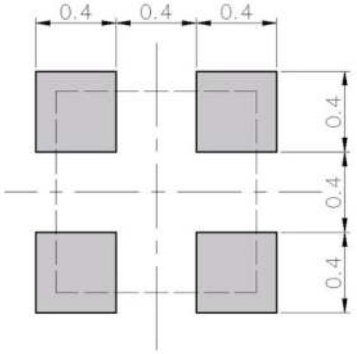
Series	Emitting Color	VF(V)		Wavelength λ(nm)			IV(mcd)	2θ1/2
		Typ.	Max.	λ_D	λ_P	△λ	Typical	
IN-B101FCH	Red	2.0	2.4	621	629	16	58	140
	Green	2.8	3.4	531	520	32	85	140
	Blue	3.0	3.4	470	480	22	17	140

Package Outline Dimension & Recommended Soldering Pattern for Soldering

Outline Dim.



Soldering Pattern



Soldering terminals may shift in the x, y direction. Unit: mm Tolerance: +/-0.1mm

Absolute Maximum Ratings

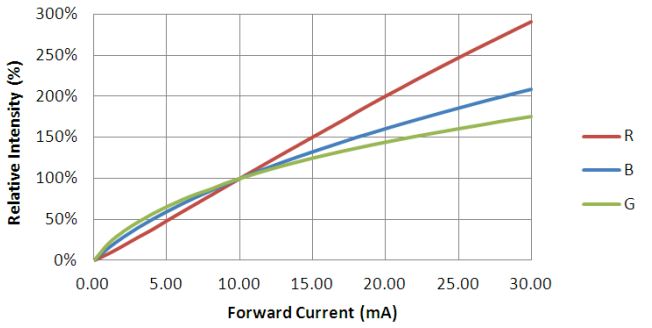
(T_a 25 °C)

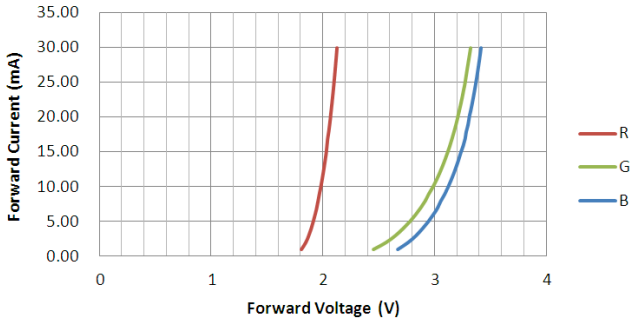
Series	P_d (mW)	I_F (mA)	I_{FP} (mA)	I_R (uA)	T_{OP} (°C)
Color	Power Dissipation	Forward Current	Pulse Forward Current	Operating Temperature	Storage Temperature
Red	150	10	60	-30~+80	-40~+85
Blue	150	5	60	-30~+80	-40~+85
Green	150	5	60	-30~+80	-40~+85

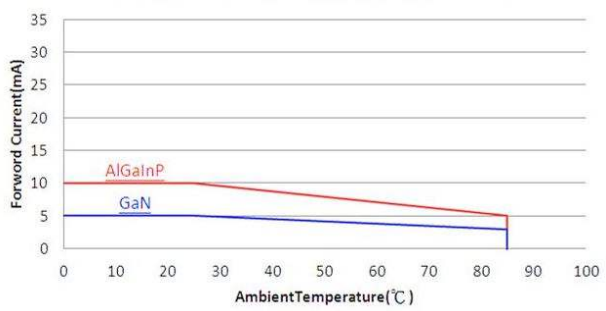
** Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

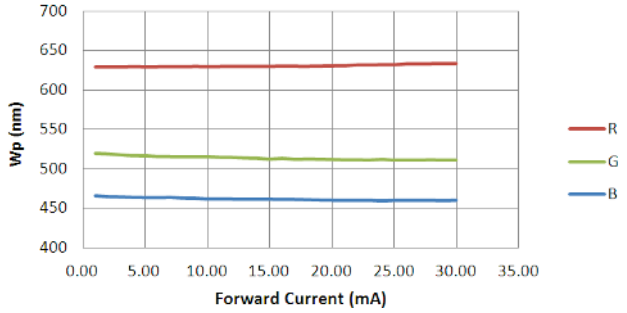
Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

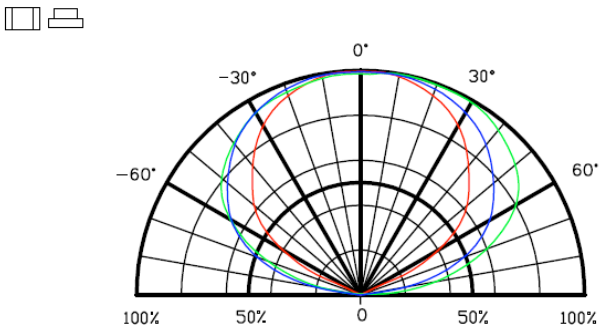
Characteristics of IN-B101FCH

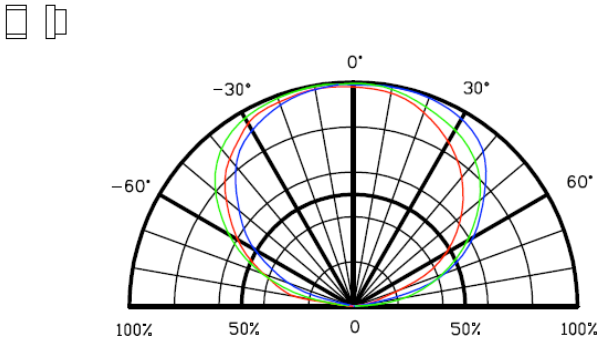






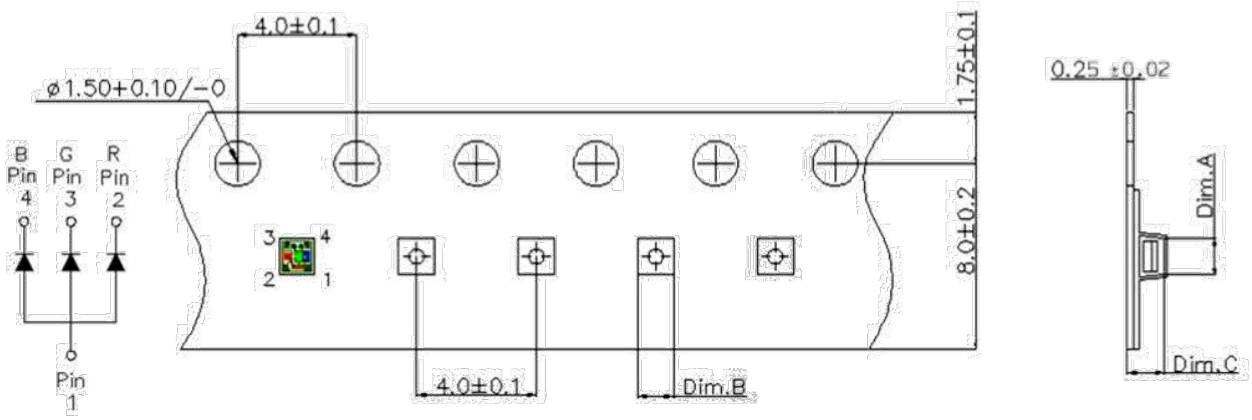




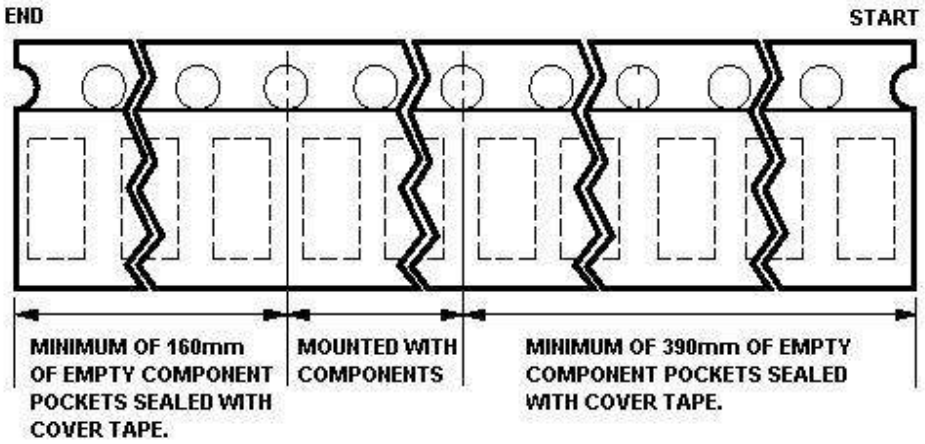


Packaging

Tape Dimension

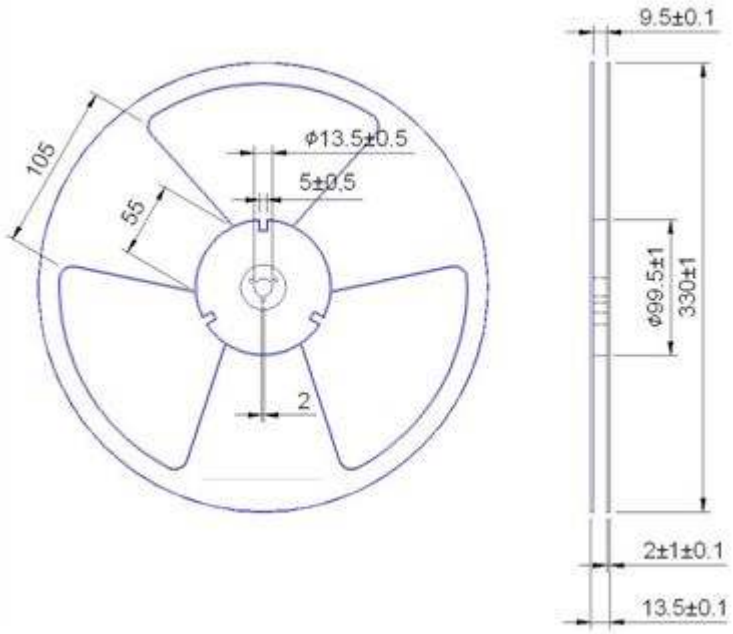


Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.22±0.05	1.22±0.05	0.78±0.05	24K



Unit: mm

Reel Dimension



Unit: mm Tolerance: +/-0.15mm

Precautions

Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30℃ or less and 80%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30℃ or less and 60%RH or less.

2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5℃ for 24 hours.

3. Soldering Condition

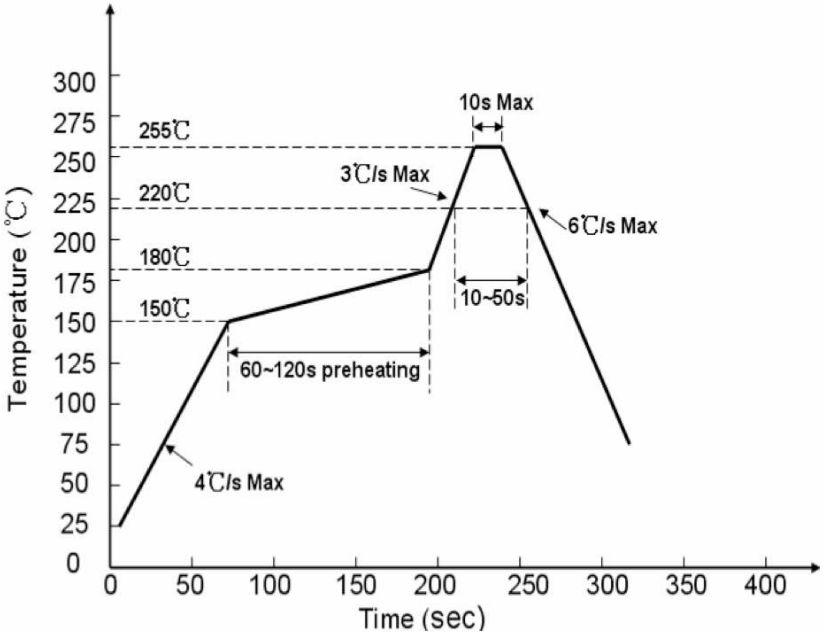
When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering Iron		Lead Free Wave Soldering	
Temperature	300℃ Max.	Pre-heat	150℃ Max.
Soldering Time	3 sec. Max.	Pre-heat Time	120 sec. Max.
	(One time only)	Solder Wave	260℃ Max.
		Soldering Time	10 sec. Max.



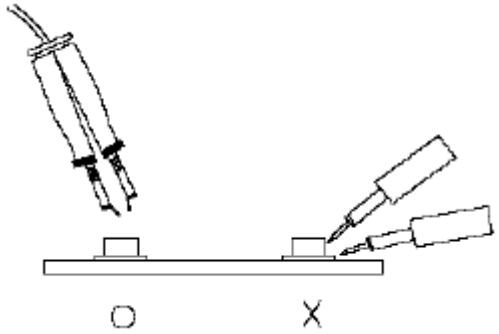
Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260℃ for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial release	-	1.0	04-10-2015